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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/855,820	05/14/2001	Ruben Madrid	018865007400	9693
20350 7	590 01/29/2003			
TOWNSEND AND TOWNSEND AND CREW, LLP TWO EMBARCADERO CENTER EIGHTH FLOOR			EXAMINER	
			WOJCIECHOWICZ, EDWARD JOSEPH	
SAN FRANCI	SCO, CA 94111-3834		ART UNIT	PAPER NUMBER
			2815	-

Please find below and/or attached an Office communication concerning this application or proceeding.



MC

Application No.

09/855,820

Applicant(s)

Madrid

Office Action Summary Examiner

Edward Wojciechowicz

Art Unit 2815



•	The MAILING DATE of this communication appears of	on the cover :	The MAILING DATE of this communication appears on the cover sheet with the correspondence address					
	for Reply							
THE	A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE <u>3</u> MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.							
- Extensions of time may be available under the provisions of 37 CFR 1.136 (a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.								
- If NO p - Failure - Any re	period for reply specified above is less than thirty (30) days, a reply within the period for reply is specified above, the maximum statutory period will apply an to reply within the set or extended period for reply will, by statute, cause the ply received by the Office later than three months after the mailing date of th patent term adjustment. See 37 CFR 1.704(b).	nd will expire SIX e application to be	(6) MONTHS fi come ABAND(rom the mailing date of this communication. DNED (35 U.S.C. § 133).				
Status								
1) 💢	Responsive to communication(s) filed on Nov 15, 20	002		•				
2a) 🗌	This action is FINAL . 2b) ✓ This action	on is non-fin	al.					
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11; 453 O.G. 213.								
Disposi	tion of Claims							
4) 💢	Claim(s) 24, 26, 27, and 29-37			is/are pending in the application.				
4	a) Of the above, claim(s)		,	is/are withdrawn from consideration.				
5) 🗆	Claim(s)			is/are allowed.				
6) 💢	Claim(s) 24, 26, 27, and 29-37			is/are rejected.				
7) 🗆	Claim(s)			is/are objected to.				
8) 🗆	Claims	a	re subject	to restriction and/or election requirement.				
Applica	tion Papers							
9) 🗆	The specification is objected to by the Examiner.							
10) \boxtimes The drawing(s) filed on <u>Oct 28, 2002</u> is/are a) \boxtimes accepted or b) \square objected to by the Examiner.								
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).								
11) The proposed drawing correction filed on is: a) approved b) disapproved by the Examine								
If approved, corrected drawings are required in reply to this Office action.								
12) The oath or declaration is objected to by the Examiner.								
Priority under 35 U.S.C. §§ 119 and 120								
13) Acknowledgement is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).								
a) □ All b) □ Some* c) □ None of:								
1. Certified copies of the priority documents have been received.								
2. Certified copies of the priority documents have been received in Application No.								
	3. Copies of the certified copies of the priority do application from the International Burea	au (PCT Rule	17.2(a)).					
*See the attached detailed Office action for a list of the certified copies not received.								
14) Acknowledgement is made of a claim for domestic priority under 35 U.S.C. § 119(e).								
 a) ☐ The translation of the foreign language provisional application has been received. 15)☐ Acknowledgement is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121. 								
Attachm	·	priority dride	55 6.5.	C. 33 120 dilu/01 121.				
_	enrys) stice of References Cited (PTO-892)	4) Interview	Summary (PT0	0-413) Paper No(s)				
	otice of Draftsperson's Patent Drawing Review (PTO-948)	_		t Application (PTO-152)				
3) [] Int	formation Disclosure Statement(s) (PTO-1449) Paper No(s).	6) Other:						

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DETAILED ACTION

Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (e) the invention was described in-
- (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effect under this subsection of a national application published under section 122(b) only if the international application designating the United States was published under Article 21(2)(a) of such treaty in the English language; or
- (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that a patent shall not be deemed filed in the United States for the purposes of this subsection based on the filing of an international application filed under the treaty defined in section 351(a).
- 2. Claims 24, 26, 27, 29-33, and 35-37 are rejected under 35 U.S.C. 102(e) as being anticipated by Tan et al. The newly cited reference to Tan et al shows the claimed process for forming a carrier for a semiconductor die, including the formation of "bumps" in a metal layer, where the bumps are formed by "stamping". See, for example, Fig. 5 of Tan with bumps (110) which are electrically coupled to conductive regions of the semiconductor die (504) which is also attached to the carrier. In addition, as seen in Fig. 3b of Tan, the bumps (110) may also be formed in a conical shape, as claimed.

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Furthermore, Tan discloses the use of copper as a common material for forming the carrier, and the bumps are arranged around the die attach area, as well. Also, Tan may optionally form a dielectric layer (502) on the metal layer.

Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. Claim 34 is rejected under 35 U.S.C. 103(a) as being unpatentable over Tan as applied to claim above, and further in view of Shrier et al. Shrier also shows the inventive concept of applicant's invention with a metal carrier member having bumps formed by stamping, see the discussion at paragraph [0071]. In addition, as seen in Fig. 15 of Shrier, additional sublayers of material (101) and (107) are formed on the base layer (105), as claimed. The motivation to combine these references comes from the teaching in Shrier that this additional layer enhances the electrical characteristics of the device.

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5. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Edward Wojciechowicz, whose telephone number is (703) 308-4898, or to SPE Eddie Lee whose number is 703-308-1690.

Edward Wojciechowicz:ew

January 27, 2003

PAIMARY EXAMINER
GROUP 2500

EDWARD WOOCHCHOMICZ